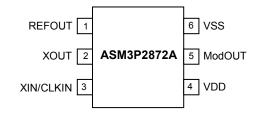
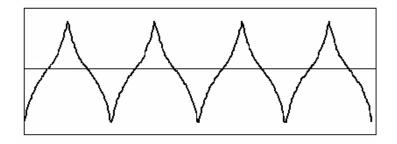
## Pin Configuration (6L-TSOP Package)



#### **Pin Description**

Pin#	Pin Name	Туре	Description
1	REFOUT	0	Buffered output of the input frequency.
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.
3	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
4	VDD	Р	Power supply for the entire chip.
5	ModOUT	0	Spread spectrum clock output.
6	VSS	Р	Ground connection.

#### **Modulation Profile**



#### Specifications

Description		Specification
	For 2.5V Supply	13MHz < CLKIN < 30MHz
Frequency Range	For 3.3V Supply	13MHz < CLKIN < 30MHz
Modulation Equation		F <sub>IN</sub> /640
Frequency Deviation		-1.25% @ 22MHz

#### Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit			
VDD, V <sub>IN</sub>	Voltage on any pin with respect to Ground	-0.5 to +4.6	V			
T <sub>STG</sub>	Storage temperature	-65 to +125	C			
Ts	Max. Soldering Temperature (10 sec)	260	C			
TJ	Junction Temperature	150	C			
T <sub>DV</sub>	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV			
	Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.					

### **Operating Conditions**

Parameter	Description	Min	Max	Unit
VDD	Supply Voltage	2.375	3.6	V
T <sub>A</sub>	Operating Temperature (Ambient Temperature)	0	70	C
CL	Load Capacitance		15	pF
C <sub>IN</sub>	Input Capacitance		7	pF

#### DC Electrical Characteristics for 2.5V Supply

Symbol	Parameter	Min	Тур	Мах	Unit
VIL	Input low voltage	VSS-0.3		0.8	V
VIH	Input high voltage	2.0		VDD+0.3	V
IIL	Input low current			-35	μA
I <sub>IH</sub>	Input high current			35	μA
I <sub>XOL</sub>	XOUT output low current (@ 0.5V, VDD = 2.5V)		3		mA
I <sub>XOH</sub>	XOUT output high current (@ 1.8V, VDD = 2.5V)		3		mA
V <sub>OL</sub>	Output low voltage (VDD = 2.5 V, I <sub>OL</sub> = 8mA)			0.6	V
V <sub>OH</sub>	Output high voltage (VDD = 2.5 V, I <sub>OH</sub> = 8mA)	1.8			V
I <sub>DD</sub>	Static supply current <sup>1</sup>		1.1		mA
Icc	Dynamic supply current (2.5V, 30MHz and with no load)		4.0		mA
VDD	Operating voltage	2.375	2.5	2.625	V
t <sub>on</sub>	Power-up time (first locked cycle after power-up)			5	mS
Z <sub>OUT</sub>	Output impedance		50		Ω
Note: 1. XIN /	CLKIN pin is pulled low.		·	•	

Symbol	Pa	Min	Тур	Max	Unit	
CLKIN	Input frequency		13		30	MHz
ModOUT	Output frequency		13		30	MHz
f	Fraguency Deviation	Input Frequency = 13MHz		-1.85		%
f <sub>d</sub>	Frequency Deviation	Input Frequency = 30MHz		-0.9		
t <sub>LH</sub> 1	Output rise time (measu	0.7	1.5	1.7	nS	
t <sub>HL</sub> 1	Output fall time (measur	0.5	0.9	1.1	nS	
t <sub>JC</sub>	Jitter (cycle-to-cycle)		±200		pS	
t <sub>D</sub>	Output duty cycle	45	50	55	%	
Note: 1. $t_{LH}$ and $t_{HI}$	are measured into a capacitive l	oad of 15pF.	•			

#### AC Electrical Characteristics for 2.5V Supply

#### DC Electrical Characteristics for 3.3V Supply

Symbol	Parameter	Min	Тур	Max	Unit
VIL	Input low voltage	VSS-0.3		0.8	V
V <sub>IH</sub>	Input high voltage	2.0		VDD+0.3	V
I⊫	Input low current			-35	μA
I <sub>IH</sub>	Input high current			35	μA
I <sub>XOL</sub>	XOUT output low current (@ 0.4V, VDD = 3.3V)		3		mA
I <sub>XOH</sub>	XOUT output high current (@ 2.5V, VDD = 3.3V)		3		mA
V <sub>OL</sub>	Output low voltage (VDD = 3.3 V, I <sub>OL</sub> = 8mA)			0.4	V
V <sub>OH</sub>	Output high voltage (VDD = 3.3 V, I <sub>OH</sub> = 8mA)	2.5			V
I <sub>DD</sub>	Static supply current <sup>1</sup>		1.2		mA
Icc	Dynamic supply current (3.3V, 30MHz and with no load)		5.5		mA
VDD	Operating voltage	2.7	3.3	3.6	V
t <sub>ON</sub>	Power-up time (first locked cycle after power-up)			5	mS
Zout	Output impedance		45		Ω
Note: 1. XIN	CLKIN pin is pulled low.				

Symbol	Pa	Min	Тур	Мах	Unit	
CLKIN	Input frequency	Input frequency			30	MHz
ModOUT	Output frequency		13		30	MHz
£		Input Frequency = 13MHz		-1.85		0/
f <sub>d</sub>	Frequency Deviation Input Frequency = 30MHz			-0.9		%
t <sub>LH</sub> 1	Output rise time (measu	Output rise time (measured from 0.8 to 2.0V)			1.7	nS
t <sub>HL</sub> <sup>1</sup>	Output fall time (measur	Output fall time (measured at 2.0V to 0.8V)			1.1	nS
t <sub>JC</sub>	Jitter (cycle-to-cycle)	Jitter (cycle-to-cycle)				pS
t <sub>D</sub>	Output duty cycle	45	50	55	%	
Note: 1. $t_{LH}$ and $t_{HL}$ are	measured into a capacitive load of	f 15pF.				

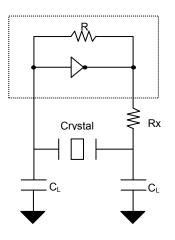
#### **AC Electrical Characteristics for 3.3V Supply**

#### **Typical Crystal Specifications**

Fundamental AT cut parallel resonant crystal				
Nominal frequency	14.31818MHz			
Frequency tolerance	± 50 ppm or better at 25℃			
Operating temperature range	-25℃ to +85℃			
Storage temperature	-40℃ to +85℃			
Load capacitance(C <sub>P</sub> )	18pF			
Shunt capacitance	7pF maximum			
ESR	25 Ω			

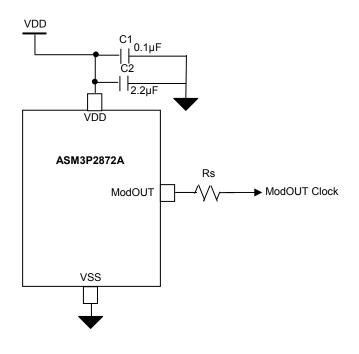
Note: Note: C<sub>L</sub> is Load Capacitance and Rx is used to prevent oscillations at overtone frequency of the Fundamental frequency.

#### **Typical Crystal Interface Circuit**



 $C_L = 2^*(C_P - C_S), \\ Where C_P = Load capacitance of crystal \\ C_S = Stray capacitance due to C_{IN,} PCB, Trace etc.$ 

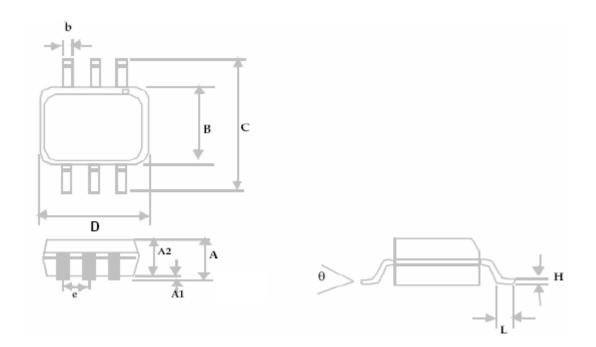
#### **Typical Application Schematic**



# ASM3P2872A

#### Package Information

6L-TSOP Package



	Dimensions					
Symbol	Inc	hes	Millimeters			
	Min	Max	Min	Мах		
А		0.04		1.00		
A1	0.00	0.004	0.00	0.10		
A2	0.033	0.036	0.84	0.90		
b	0.012	0.02	0.30	0.50		
Н	0.005	5 BSC	0.127	BSC		
D	0.114	BSC	2.90	BSC		
В	0.06	BSC	1.60	BSC		
е	0.0374 BSC		0.950 BSC			
С	0.11 BSC		2.80 BSC			
L	0.0118	0.02	0.30	0.50		
θ	0°	4°	0°	4°		

#### **Ordering Information**

Part Number	Marking	Package Type	Temperature
ASM3P2872AF-06OR	B4L	6L-TSOP (6L-TSOT-23), TAPE & REEL, Pb Free	0℃ to +70℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.

**ON Semiconductor** and <sup>(IIII)</sup> are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. U.S Patent Pending; Timing-Safe and Active Bead are trademarks of PulseCore Semiconductor, a wholly owned subsidiary of ON Semiconductor. This literature is subject to all applicable cop

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

# ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative